

Welcome to [E-XFL.COM](#)

What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	RXv2
Core Size	32-Bit Single-Core
Speed	240MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I ² C, MMC/SD, QSPI, SCI, SPI, SSI, USB OTG
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	78
Program Memory Size	4MB (4M x 8)
Program Memory Type	FLASH
EEPROM Size	64K x 8
RAM Size	512K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x12b, 14x12b; D/A 1x12
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TFLGA
Supplier Device Package	100-TFLGA (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f571mlddlj-20

Table 1.1 Outline of Specifications (3/10)

Classification	Module/Function	Description
Low power consumption	Low power consumption facilities	<ul style="list-style-type: none"> Module stop function Four low power consumption modes Sleep mode, all-module clock stop mode, software standby mode, and deep software standby mode
	Battery backup function	<ul style="list-style-type: none"> When the voltage on the VCC pin drops, battery power from the VBATT pin is supplied to keep the real-time clock (RTC) operating.
Interrupt	Interrupt controller (ICUA)	<ul style="list-style-type: none"> Peripheral function interrupts: 298 sources External interrupts: 16 (pins IRQ0 to IRQ15) Software interrupts: 2 sources Non-maskable interrupts: 7 sources Sixteen levels specifiable for the order of priority Method of interrupt source selection: The interrupt vectors consist of 256 vectors (128 sources are fixed. The remaining 128 vectors are selected from among the other 157 sources.)
External bus extension		<ul style="list-style-type: none"> The external address space can be divided into eight areas (CS0 to CS7), each with independent control of access settings. Capacity of each area: 16 Mbytes (CS0 to CS7) A chip-select signal (CS0# to CS7#) can be output for each area. Each area is specifiable as an 8-, 16-, or 32-bit bus space. The data arrangement in each area is selectable as little or big endian (only for data). SDRAM interface connectable Bus format: Separate bus, multiplex bus Wait control Write buffer facility
DMA	DMA controller (DMACAA)	<ul style="list-style-type: none"> 8 channels Three transfer modes: Normal transfer, repeat transfer, and block transfer Activation sources: Software trigger, external interrupts, and interrupt requests from peripheral functions
	EXDMA controller (EXDMACa)	<ul style="list-style-type: none"> 2 channels Four transfer modes: Normal transfer, repeat transfer, block transfer, and cluster transfer Single-address transfer enabled with the EDACKn signal Activation sources: Software trigger, external DMA requests (EDREQn), and interrupt requests from peripheral functions
	Data transfer controller (DTCa)	<ul style="list-style-type: none"> Three transfer modes: Normal transfer, repeat transfer, and block transfer Activation sources: External interrupts and interrupt requests from peripheral functions
I/O ports	Programmable I/O ports	<ul style="list-style-type: none"> I/O ports for the 177-pin TFLGA (in planning), 176-pin LFBGA (in planning), and 176-pin LQFP I/O pins: 127 Input pin: 1 Pull-up resistors: 127 Open-drain outputs: 127 5-V tolerance: 19 I/O ports for the 145-pin TFLGA (in planning) and 144-pin LQFP I/O pins: 111 Input pin: 1 Pull-up resistors: 111 Open-drain outputs: 111 5-V tolerance: 18 I/O ports for the 100-pin TFLGA (in planning) and 100-pin LQFP I/O pins: 78 Input pin: 1 Pull-up resistors: 78 Open-drain outputs: 78 5-V tolerance: 17

Table 1.3 List of Products (3/3)

Group	Part No.	Package	Code Flash Memory Capacity	RAM Capacity	Data Flash Memory Capacity	Operating Frequency (Max.)	Encryption Module	SDHI
RX71M	R5F571MFCDLK	PTLG0145KA-A*1	2 Mbytes	512 Kbytes	64 Kbytes	240 MHz	Not supported	Not supported
	R5F571MFDDLK	PTLG0145KA-A*1	2 Mbytes	512 Kbytes	64 Kbytes	240 MHz	Not supported	Available
	R5F571MFGDLK	PTLG0145KA-A*1	2 Mbytes	512 Kbytes	64 Kbytes	240 MHz	Available	Not supported
	R5F571MFHDLK	PTLG0145KA-A*1	2 Mbytes	512 Kbytes	64 Kbytes	240 MHz	Available	Available
	R5F571MLCDLJ	PTLG0100JA-A*1	4 Mbytes	512 Kbytes	64 Kbytes	240 MHz	Not supported	Not supported
	R5F571MLDDLJ	PTLG0100JA-A*1	4 Mbytes	512 Kbytes	64 Kbytes	240 MHz	Not supported	Available
	R5F571MLGDLJ	PTLG0100JA-A*1	4 Mbytes	512 Kbytes	64 Kbytes	240 MHz	Available	Not supported
	R5F571MLHDLJ	PTLG0100JA-A*1	4 Mbytes	512 Kbytes	64 Kbytes	240 MHz	Available	Available
	R5F571MJCDLJ	PTLG0100JA-A*1	3 Mbytes	512 Kbytes	64 Kbytes	240 MHz	Not supported	Not supported
	R5F571MJDDLJ	PTLG0100JA-A*1	3 Mbytes	512 Kbytes	64 Kbytes	240 MHz	Not supported	Available
	R5F571MJGDLJ	PTLG0100JA-A*1	3 Mbytes	512 Kbytes	64 Kbytes	240 MHz	Available	Not supported
	R5F571MJHDLJ	PTLG0100JA-A*1	3 Mbytes	512 Kbytes	64 Kbytes	240 MHz	Available	Available
	R5F571MGCDLJ	PTLG0100JA-A*1	2.5 Mbytes	512 Kbytes	64 Kbytes	240 MHz	Not supported	Not supported
	R5F571MGDDLJ	PTLG0100JA-A*1	2.5 Mbytes	512 Kbytes	64 Kbytes	240 MHz	Not supported	Available
	R5F571MGGDLJ	PTLG0100JA-A*1	2.5 Mbytes	512 Kbytes	64 Kbytes	240 MHz	Available	Not supported
	R5F571MGHDLJ	PTLG0100JA-A*1	2.5 Mbytes	512 Kbytes	64 Kbytes	240 MHz	Available	Available
	R5F571MFCDLJ	PTLG0100JA-A*1	2 Mbytes	512 Kbytes	64 Kbytes	240 MHz	Not supported	Not supported
	R5F571MFDDLJ	PTLG0100JA-A*1	2 Mbytes	512 Kbytes	64 Kbytes	240 MHz	Not supported	Available
	R5F571MFGDLJ	PTLG0100JA-A*1	2 Mbytes	512 Kbytes	64 Kbytes	240 MHz	Available	Not supported
	R5F571MFHDLJ	PTLG0100JA-A*1	2 Mbytes	512 Kbytes	64 Kbytes	240 MHz	Available	Available

Note 1. Under planning

Table 1.5 List of Pin and Pin Functions (177-Pin TFLGA, 176-Pin LFBGA) (2/7)

Pin Number 177-Pin TFLGA 176-Pin LFBGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, GPT, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCIg, SCIh, RSPI, I2C, CAN, USB, SSI)	Memory Interface Camera Interface (QSPI, SDHI, MMCIF, PDC)	Interrupt	S12ADC, R12DA
C4		P43					IRQ11-DS	AN003
C5		P45					IRQ13-DS	AN005
C6		P90	A16/D16		ET1_RX_DV/ TXD7/SMOSI7/SSDA7			AN114
C7		PD0	D0[A0/D0]	GTIOC1B-E/POE4#			IRQ0	AN108
C8		PD2	D2[A2/D2]	MTIOC4D/ GTIOC0B-E/TIC2	CRX0	MMC_D2-B/ SDHI_D2-B/ QIO2_B	IRQ2	AN110
C9		PD3	D3[A3/D3]	MTIOC8D/ GTIOC0A-E/POE8#/ TOC2		MMC_D3-B/ SDHI_D3-B/ QIO3_B	IRQ3	AN111
C10		PG0	D24		ET1_RX_CLK/ REF50CK1			
C11	VCC							
C12		P62	CS2#/RAS#					
C13		PE4	D12[A12/D12]	MTIOC4D/MTIOC1A/ GTIOC1A-A/PO28	ET0_ERXD2/SSLB0-B			AN102
C14	VSS							
C15		P70	SDCLK					
D1		P01		TMC10	RXD6/SMISO6/ SSCL6		IRQ9	AN119
D2		P02		TMC11	SCK6		IRQ10	AN120
D3		P03					IRQ11	DA0
D4		P00		TMRI0	TXD6/SMOSI6/ SSDA6		IRQ8	AN118
D5		P44					IRQ12-DS	AN004
D6		P93	A19/D19	POE0#	ET1_LINKSTA/CTS7#/ RTS7#/SS7#			AN117
D7		P95	A21/D21		ET1_ERXD1/ RMII1_RXD1			
D8	VSS							
D9		PD5	D5[A5/D5]	MTIC5W/MTIOC8C/ POE10#		MMC_CLK-B/ SDHI_CLK-B/ QSPCLK-B	IRQ5	AN113
D10		PD7	D7[A7/D7]	MTIC5U/POE0#		MMC_D1-B/ SDHI_D1-B/ QIO1-B/QMI-B	IRQ7	AN107
D11		P61	CS1#/SDCS#					
D12		PE5	D13[A13/D13]	MTIOC4C/MTIOC2B/ GTIOC0A-A	ET0_RX_CLK/ REF50CK0/ RSPCKB-B		IRQ5	AN103
D13	VCC							
D14		PE7	D15[A15/D15]	MTIOC6A/ GTIOC3A-E/TOC1	MISOB-B	MMC_RES#-B/ SDHI_WP-B	IRQ7	AN105
D15		P65	CS5#/CKE					
E1		PJ5		POE8#	CTS2#/RTS2#/SS2#			
E2	EMLE							
E3		PF5					IRQ4	
E4	VSS							
E5 ^{*1}								
E12		PE6	D14[A14/D14]	MTIOC6C/ GTIOC3B-E/TIC1	MOSIB-B	MMC_CD-B/ SDHI_CD-B	IRQ6	AN104

Table 1.6 List of Pin and Pin Functions (176-Pin LQFP) (6/7)

Pin Number	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, GPT, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCIG, SCH, RSPI, RIIC, CAN, USB, SSI)	Memory Interface Camera Interface		
141		P60	CS0#		ET1_TX_EN/ RMII1_RXD_EN			S12ADC, R12DA
142	VCC							
143		PD7	D7[A7/D7]	MTIC5U/POE0#		MMC_D1-B/ SDHI_D1-B/ QIO1-B/QMI-B	IRQ7	AN107
144		PG1	D25		ET1_RX_ER/ RMII1_RX_ER			
145		PD6	D6[A6/D6]	MTIC5V/MTIOC8A/ POE4#		MMC_D0-B/ SDHI_D0-B/ QIO0-B/ QMO-B	IRQ6	AN106
146		PG0	D24		ET1_RX_CLK/ REF50CK1			
147		PD5	D5[A5/D5]	MTIC5W/MTIOC8C/ POE10#		MMC_CLK-B/ SDHI_CLK-B/ QSPCLK-B	IRQ5	AN113
148		PD4	D4[A4/D4]	MTIOC8B/POE11#		MMC_CMD-B/ SDHI_CMD-B/ QSSL-B	IRQ4	AN112
149		P97	A23/D23		ET1_ERXD3			
150		PD3	D3[A3/D3]	MTIOC8D/ GTIOC0A-E/POE8#/ TOC2		MMC_D3-B/ SDHI_D3-B/ QIO3-B	IRQ3	AN111
151	VSS							
152		P96	A22/D22		ET1_ERXD2			
153	VCC							
154		PD2	D2[A2/D2]	MTIOC4D/ GTIOC0B-E/TIC2	CRX0	MMC_D2-B/ SDHI_D2-B/ QIO2_B	IRQ2	AN110
155		P95	A21/D21		ET1_ERXD1/ RMII1_RXD1			
156		PD1	D1[A1/D1]	MTIOC4B/ GTIOC1A-E/POE0#	CTX0		IRQ1	AN109
157		P94	A20/D20		ET1_ERXD0/ RMII1_RXD0			
158		PD0	D0[A0/D0]	GTIOC1B-E/POE4#			IRQ0	AN108
159		P93	A19/D19	POE0#	ET1_LINKSTA/CTS7#/ RTS7#/SS7#			AN117
160		P92	A18/D18	POE4#	ET1_CRS/ RMII1_CRS_DV/ RXD7/SMISO7/SSCL7			AN116
161		P91	A17/D17		ET1_COL/SCK7			AN115
162	VSS							
163		P90	A16/D16		ET1_RX_DV/ TXD7/SMOSI7/SSDA7			AN114
164	VCC							
165		P47					IRQ15-DS	AN007
166		P46					IRQ14-DS	AN006
167		P45					IRQ13-DS	AN005
168		P44					IRQ12-DS	AN004
169		P43					IRQ11-DS	AN003
170		P42					IRQ10-DS	AN002

Table 1.7 List of Pin and Pin Functions (145-Pin TFLGA) (2/5)

Pin Number 145-Pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, GPT, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCIG, SCH, RSPI, RIIC, CAN, USB, SSI)	Memory Interface Camera Interface (QSPI, SDHI, MMCIF, PDC)	Interrupt	S12ADC, R12DA
C9		PD7	D7[A7/D7]	MTIC5U/POE0#		MMC_D1-B/ SDHI_D1-B/ QIO1-B/QMI-B	IRQ7	AN107
C10		P63	CS3#/CAS#					
C11		PE0	D8[A8/D8]	MTIOC3D/ GTIOC2B-A	SCK12/SSLB1-B	MMC_D4-B		ANEX0
C12		P70	SDCLK					
C13	VSS							
D1		P00		TMRI0	TXD6/SMOSI6/SSDA6		IRQ8	AN118
D2		PF5					IRQ4	
D3		P03					IRQ11	DA0
D4		P01		TMCI0	RXD6/SMISO6/SSCL6		IRQ9	AN119
D5	VCC							
D6		P93	A19	POE0#	CTS7#/RTS7#/SS7#			AN117
D7		PD5	D5[A5/D5]	MTIC5W/MTIOC8C/ POE10#		MMC_CLK-B/ SDHI_CLK-B/ QSPCLK-B	IRQ5	AN113
D8		P60	CS0#					
D9		P64	CS4#/WE#					
D10		PE7	D15[A15/D15]	MTIOC6A/ GTIOC3A-E/TOC1	MISOB-B	MMC_RES#/B/ SDHI_WP-B	IRQ7	AN105
D11	VCC							
D12		PE5	D13[A13/D13]	MTIOC4C/MTIOC2B/ GTIOC0A-A	ET0_RX_CLK/ REF50CK0/ RSPCKB-B		IRQ5	AN103
D13		PE6	D14[A14/D14]	TIOC6C/GTIOC3B-E/ TIC1	MOSIB-B	MMC_CD-B/ SDHI_CD-B	IRQ6	AN104
E1	VSS							
E2	VCL							
E3		PJ5		POE8#	CTS2#/RTS2#/SS2#			
E4	EMLE							
E5		P44					IRQ12-DS	AN004
E10		PA0	A0/BC0#	MTIOC4A/MTIOC6D/ GTIOC0B-C/TIOCA0/ CACREF/PO16	SSLA1-B/ ET0_TX_EN/ RMII_TXD_EN			
E11		P66	CS6#/DQM0	MTIOC7D/ GTIOC2B-C	CTX2			
E12		P65	CS5#/CKE					
E13		P67	CS7#/DQM1	MTIOC7C/ GTIOC1B-C	CRX2		IRQ15	
F1	XCIN							
F2	XCOUT							
F3		PJ3	EDACK1	MTIOC3C	ET0_EXOUT/CTS6#/RTS6#/CTS0#/RTS0#/SS6#/SS0#			
F4	VBATT							
F10		PA3	A3	MTIOC0D/MTCLKD/ TIOCD0/TCLKB/PO19	RXD5/SMISO5/ SSCL5/ET0_MDIO		IRQ6-DS	
F11	VSS							
F12		PA1	A1	MTIOC0B/MTCLKC/ MTIOC7B/ GTIOC2A-C/TIOCB0/ PO17	SCK5/SSLA2-B/ ET0_WOL		IRQ11	

Table 1.8 List of Pin and Pin Functions (144-Pin LQFP) (3/5)

Pin Number	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, GPT, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCIG, SCH, RSPI, RIIC, CAN, USB, SSI)	Memory Interface Camera Interface	Interrupt	S12ADC, R12DA
62		PC5	A21/CS2#/WAIT#	MTIOC3B/MTCLKD/ GTIOC1A-D/TMRI2/ PO29	SCK8/RSPCKA-A/ RTS8#/ET0_ETXD2	MMC_D5-A		
63	TRSYNC	P82	EDREQ1	MTIOC4A/ GTIOC2A-D/PO28	TXD10/ET0_ETXD1/ RMII0_TXD1	MMC_D4-A		
64	TRDATA1	P81	EDACK0	MTIOC3D/ GTIOC0B-D/PO27	RXD10/ET0_ETXD0/ RMII0_TXD0	MMC_D3-A/ SDHI_CD-A/ QIO3-A		
65	TRDATA0	P80	EDREQ0	MTIOC3B/PO26	SCK10/RTS10#/ET0_RX_EN/ RMII0_TXD_EN	MMC_D2-A/ SDHI_WP-A/ QIO2-A		
66		PC4	A20/CS3#	MTIOC3D/MTCLKC/ GTETRG-D/TMC1I/ PO25/POE0#	SCK5/CTS8#/SSLA0-A/ ET0_TX_CLK/	MMC_D1-A/ SDHI_D1-A/ QIO1-A/QMI-A		
67		PC3	A19	MTIOC4D/ GTIOC1B-D/TCLKB/ PO24	TXD5/SMOSI5/ SSDA5/ET0_RX_ER	MMC_D0-A/ SDHI_D0-A/ QIO0-A/ QMO-A		
68		P77	CS7#	PO23	TXD11/ET0_RX_ER/ RMII0_RX_ER	MMC_CLK-A/ SDHI_CLK-A/ QSPCLK-A		
69		P76	CS6#	PO22	RXD11/ET0_RX_CLK/ REF50CK0	MMC_CMD-A/ SDHI_CMD-A/ QSSL-A		
70		PC2	A18	MTIOC4B/ GTIOC2B-D/TCLKA/ PO21	RXD5/SMISO5/ SSCL5/SSLA3-A/ ET0_RX_DV	MMC_CD-A/ SDHI_D3-A		
71		P75	CS5#	PO20	SCK11/RTS11/ ET0_ERXD0/ RMII0_RXD0	MMC_RES#-A/ SDHI_D2-A		
72		P74	A20/CS4#	PO19	CTS11#/ET0_ERXD1/ RMII0_RXD1			
73		PC1	A17	MTIOC3A/TCLKD/ PO18	SCK5/SSLA2-A/ ET0_ERXD2		IRQ12	
74	VCC							
75		PC0	A16	MTIOC3C/TCLKC/ PO17	CTS5#/RTS5#/SS5#/SSLA1-A/ET0_ERXD3		IRQ14	
76	VSS							
77		P73	CS3#	PO16	ET0_WOL			
78		PB7	A15	MTIOC3B/TIOCB5/ PO31	TXD9/ET0_CRS/ RMII0_CRS_DV			
79		PB6	A14	MTIOC3D/TIOCA5/ PO30	RXD9/ET0_ETXD1/ RMII0_TXD1			
80		PB5	A13	MTIOC2A/MTIOC1B/ TIOCB4/TMRI1/PO29/ POE4#	SCK9/RTS9#/ET0_ETXD0/ RMII0_TXD0			
81		PB4	A12	TIOCA4/PO28	CTS9#/ET0_RX_EN/ RMII0_TXD_EN			
82		PB3	A11	MTIOC0A/MTIOC4A/ TIOCD3/TCLKD/ TMO0/PO27/POE11#	SCK4/SCK6/ ET0_RX_ER/ RMII0_RX_ER			
83		PB2	A10	TIOCC3/TCLKC/ PO26	CTS4#/RTS4#/CTS6#/RTS6#/SS4#/SS6#/ET0_RX_CLK/ REF50CK0			
84		PB1	A9	MTIOC0C/MTIOC4C/ TIOCB3/TMC10/PO25	TXD4/TXD6/SMOSI4/ SMOSI6/SSDA4/ SSDA6/ET0_ERXD0/ RMII0_RXD0		IRQ4-DS	
85		P72	A19/CS2#		ET0_MDC			
86		P71	A18/CS1#		ET0_MDIO			

4.1 I/O Register Addresses (Address Order)

Table 4.1 List of I/O Registers (Address Order) (1 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 0000h	SYSTE M	Mode Monitor Register	MDMONR	16	16	3 ICLK		Operating Modes
0008 0002h	SYSTE M	Mode Status Register	MDSR	16	16	3 ICLK		Operating Modes
0008 0006h	SYSTE M	System Control Register 0	SYSCR0	16	16	3 ICLK		Operating Modes
0008 0008h	SYSTE M	System Control Register 1	SYSCR1	16	16	3 ICLK		Operating Modes
0008 000Ch	SYSTE M	Standby Control Register	SBYCR	16	16	3 ICLK		Low Power Consumption
0008 0010h	SYSTE M	Module Stop Control Register A	MSTPCRA	32	32	3 ICLK		Low Power Consumption
0008 0014h	SYSTE M	Module Stop Control Register B	MSTPCRB	32	32	3 ICLK		Low Power Consumption
0008 0018h	SYSTE M	Module Stop Control Register C	MSTPCRC	32	32	3 ICLK		Low Power Consumption
0008 001Ch	SYSTE M	Module Stop Control Register D	MSTPCRD	32	32	3 ICLK		Low Power Consumption
0008 0020h	SYSTE M	System Clock Control Register	SCKCR	32	32	3 ICLK		Clock Generation Circuit
0008 0024h	SYSTE M	System Clock Control Register 2	SCKCR2	16	16	3 ICLK		Clock Generation Circuit
0008 0026h	SYSTE M	System Clock Control Register 3	SCKCR3	16	16	3 ICLK		Clock Generation Circuit
0008 0028h	SYSTE M	PLL Control Register	PLLCR	16	16	3 ICLK		Clock Generation Circuit
0008 002Ah	SYSTE M	PLL Control Register 2	PLLCR2	8	8	3 ICLK		Clock Generation Circuit
0008 0030h	SYSTE M	External Bus Clock Control Register	BCKCR	8	8	3 ICLK		Clock Generation Circuit
0008 0032h	SYSTE M	Main Clock Oscillator Control Register	MOSCCR	8	8	3 ICLK		Clock Generation Circuit
0008 0033h	SYSTE M	Sub-Clock Oscillator Control Register	SOSCCR	8	8	3 ICLK		Clock Generation Circuit
0008 0034h	SYSTE M	Low-Speed On-Chip Oscillator Control Register	LOCOCR	8	8	3 ICLK		Clock Generation Circuit
0008 0035h	SYSTE M	IWDT-Dedicated On-Chip Oscillator Control Register	ILOCOCR	8	8	3 ICLK		Clock Generation Circuit
0008 0036h	SYSTE M	High-Speed On-Chip Oscillator Control Register	HOCOCR	8	8	3 ICLK		Clock Generation Circuit
0008 0037h	SYSTE M	High-Speed On-Chip Oscillator Control Register 2	HOCOCR2	8	8	3 ICLK		Clock Generation Circuit

Table 4.1 List of I/O Registers (Address Order) (67 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
000D 0564h	USBA	Deep Standby USB Suspend/Resume Interrupt Register	DPUSR1R	32	32	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than $1 + (3 +$ $BUSWAIT) \times$ (frequency ratio of ICLK/PCLKB) 5	USBAA

- Note 1. When the same output trigger is specified for pulse output groups 2 and 3 by the PPG0.PCR setting, the PPG0.NDRH address is 0008 81ECh. When different output triggers are specified, the PPG0.NDRH addresses for pulse output groups 2 and 3 are 0008 81EEh and 0008 81ECh, respectively.
- Note 2. When the same output trigger is specified for pulse output groups 0 and 1 by the PPG0.PCR setting, the PPG0.NDRL address is 0008 81EDh. When different output triggers are specified, the PPG0.NDRL addresses for pulse output groups 0 and 1 are 0008 81EFh and 0008 81EDh, respectively.
- Note 3. When the same output trigger is specified for pulse output groups 6 and 7 by the PPG1.PCR setting, the PPG1.NDRH address is 0008 81FCh. When different output triggers are specified, the PPG1.NDRH addresses for pulse output groups 6 and 7 are 0008 81FEh and 0008 81FCh, respectively.
- Note 4. When the same output trigger is specified for pulse output groups 4 and 5 by the PPG1.PCR setting, the PPG1.NDRL address is 0008 81FDh. When different output triggers are specified, the PPG1.NDRL addresses for pulse output groups 4 and 5 are 0008 81FFh and 0008 81FDh, respectively.
- Note 5. When the register is accessed while the USB is operating, a delay may be generated in accessing.

5.2 DC Characteristics

Table 5.2 DC Characteristics (1)

Conditions: $V_{CC} = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}$, $2.7 \leq V_{REFH0} \leq AVCC0$,
 $VCC_USBA = AVCC_USBA = 3.0 \text{ to } 3.6 \text{ V}$,
 $VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 \text{ V}$,
 $T_a = T_{opr}$

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Schmitt trigger input voltage	IRQ input pin* ¹ MTU input pin* ¹ GPT input pin* ¹ POE3 input pin* ¹ TPU input pin* ¹ TMR input pin* ¹ SCI input pin* ¹ ADTRG# input pin* ¹ QSPI input pin* ¹ RES#, NMI, TCK	V_{IH}	$V_{CC} \times 0.8$	—	$V_{CC} + 0.3$	V	
		V_{IL}	-0.3	—	$V_{CC} \times 0.2$		
		ΔV_T	$V_{CC} \times 0.06$	—	—		
		V_{IH}	$V_{CC} \times 0.7$	—	5.8		
		V_{IL}	-0.3	—	$V_{CC} \times 0.3$		
		ΔV_T	$V_{CC} \times 0.05$	—	—		
		V_{IH}	$V_{CC} \times 0.8$	—	5.8		
		V_{IL}	-0.3	—	$V_{CC} \times 0.2$		
		V_{IH}	$V_{CC} \times 0.8$	—	$V_{CC} + 0.3$		
		V_{IL}	-0.3	—	$V_{CC} \times 0.2$		
Input high voltage (except for Schmitt trigger input pin)	MD pin, EMLE EXTAL, RSPI input pin, EXDMAC input pin, WAIT#, SSI input pin, SDHI input pin, MMC input pin, PDC input pin ETHERC input pin XCIN* ³ D0 to D31	V_{IH}	$V_{CC} \times 0.9$	—	$V_{CC} + 0.3$	V	
			$V_{CC} \times 0.8$	—	$V_{CC} + 0.3$		
			2.3	—	$V_{CC} + 0.3$		
			$V_{CC} \times 0.8$	—	$V_{CC} + 0.3$		
			$V_{CC} \times 0.7$	—	$V_{CC} + 0.3$		
			2.1	—	$V_{CC} + 0.3$		
			—	—	—		
Input low voltage (except for Schmitt trigger input pin)	MD pin, EMLE EXTAL, RSPI input pin, EXDMAC input pin, WAIT#, SSI input pin, SDHI input pin, MMC input pin, PDC input pin XCIN* ³ D0 to D31	V_{IL}	-0.3	—	$V_{CC} \times 0.1$	V	
			-0.3	—	$V_{CC} \times 0.2$		
			-0.3	—	$V_{CC} \times 0.2$		
			-0.3	—	$V_{CC} \times 0.3$		
			-0.3	—	0.8		

Note 1. This does not include the pins, which are multiplexed as ports for 5 V tolerant.

Note 2. Ports 07, 11 to 17, 20, 21, 30 to 33, 67, and C0 to C3 are 5 V tolerant.

Note 3. For P32, P31, P30, and XCIN, input as follows when the V_{BATT} power supply is selected.

V_{IH} Min. = $V_{BATT} \times 0.8$, V_{IH} Max. = $V_{BATT} + 0.3$, V_{IL} Min. = -0.3, V_{IL} Max. = $V_{BATT} \times 0.2$ ($V_{BATT} = 2.0 \text{ to } 3.6 \text{ V}$)

Table 5.6 Permissible Output Currents

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7$ to 3.6 V, $2.7 \leq VREFH0 \leq AVCC0$,
 $VCC_USBA = AVCC_USBA = 3.0$ to 3.6 V,
 $VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0$ V,
 $T_a = T_{opr}$

Item			Symbol	Min.	Typ.	Max.	Unit
Permissible output low current (average value per pin)	All output pins* ¹	Normal drive	I_{OL}	—	—	2.0	mA
	All output pins* ²	High drive	I_{OL}	—	—	3.8	mA
Permissible output low current (max. value per pin)	All output pins* ¹	Normal drive	I_{OL}	—	—	4.0	mA
	All output pins* ²	High drive	I_{OL}	—	—	7.6	mA
Permissible output low current (total)	Total of all output pins		ΣI_{OL}	—	—	80	mA
Permissible output high current (average value per pin)	All output pins* ¹	Normal drive	I_{OH}	—	—	-2.0	mA
	USB_DPUPE pin* ²	High drive	I_{OH}	—	—	-3.8	mA
Permissible output high current (max. value per pin)	All output pins* ¹	Normal drive	I_{OH}	—	—	-4.0	mA
	All output pins* ²	High drive	I_{OH}	—	—	-7.6	mA
Permissible output high current (total)	Total of all output pins		ΣI_{OH}	—	—	-80	mA

Caution: To protect the LSI's reliability, the output current values should not exceed the values in this table.

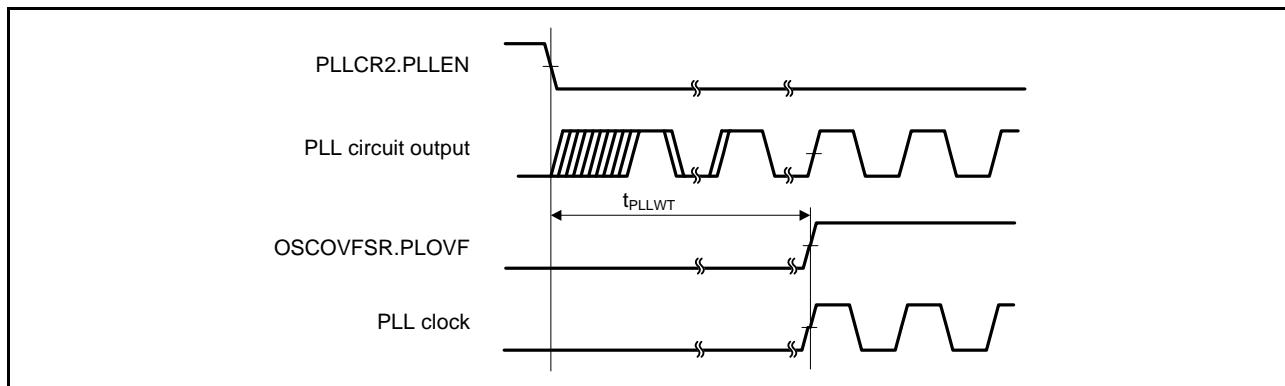
Note 1. This is the value when normal driving ability is set with a pin for which normal driving ability is selectable.

Note 2. This is the value when high driving ability is set with a pin for which normal driving ability is selectable or the value of the pin to which high driving ability is fixed.

Table 5.16 PLL Clock Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
 VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
 VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
 $T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
PLL clock oscillation frequency	f_{PLL}	120	—	240	MHz	
PLL clock oscillation stabilization wait time	t_{PLLWT}	—	259	320	μs	Figure 5.10

**Figure 5.10 PLL Clock Oscillation Start Timing****Table 5.17 Sub-Clock Timing**

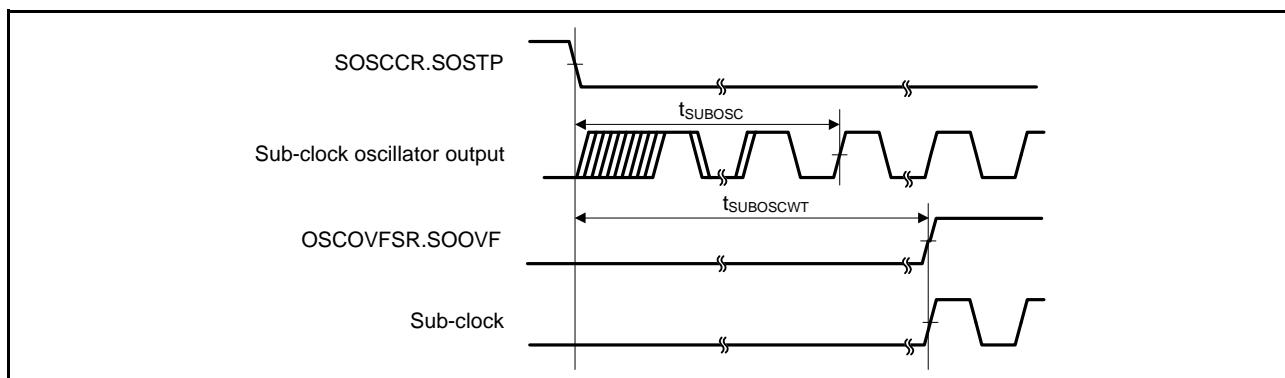
Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
 VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
 VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
 $V_{BATT} = 2.0$ to 3.6 V, $T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Sub-clock oscillation frequency	f_{SUB}	—	32.768	—	kHz	
Sub-clock oscillation stabilization time	t_{SUBOSC}	—	—	*1	s	Figure 5.11
Sub-clock oscillation stabilization wait time	$t_{SUBOSCWT}$	—	—	*2	s	

Note 1. When using a sub-clock, ask the manufacturer of the oscillator to evaluate its oscillation. Refer to the results of evaluation provided by the manufacturer for the oscillation stabilization time.

Note 2. The number of cycles selected by the value of the SOSCWTCR.SSTS[7:0] bits determines the sub-clock oscillation stabilization wait time in accord with the formula below.

$$t_{SUBOSCWT} = [(SSTS[7:0] \text{ bits} \times 16384) + 10] / f_{LOCO}$$

**Figure 5.11 Sub-Clock Oscillation Start Timing**

5.3.5 Bus Timing

Table 5.21 Bus Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}$, $2.7 \leq VREFH0 \leq AVCC0$, $VCC_USBA = AVCC_USBA = 3.0 \text{ to } 3.6 \text{ V}$, $VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 \text{ V}$, $ICLK = 8 \text{ to } 240 \text{ MHz}$, $PCLKA = 8 \text{ to } 120 \text{ MHz}$, $PCLKB = BCLK = SDCLK = 8 \text{ to } 60 \text{ MHz}$, $T_a = T_{opr}$
 Output load conditions: $V_{OH} = VCC \times 0.5$, $V_{OL} = VCC \times 0.5$, $C = 30 \text{ pF}$
 High-drive output is selected by the driving ability control register.

Item	Symbol	Min.	Max.	Unit	Test Conditions
Address delay time	t_{AD}	—	12.5	ns	Figure 5.16 to Figure 5.21
Byte control delay time	t_{BCD}	—	12.5	ns	
CS# delay time	t_{CSD}	—	12.5	ns	
ALE delay time	t_{ALED}	—	12.5	ns	
RD# delay time	t_{RSD}	—	12.5	ns	
Read data setup time	t_{RDS}	12.5	—	ns	
Read data hold time	t_{RDH}	0	—	ns	
WR# delay time	t_{WRD}	—	12.5	ns	
Write data delay time	t_{WDD}	—	12.5	ns	
Write data hold time	t_{WDH}	0	—	ns	
WAIT# setup time	t_{WTS}	12.5	—	ns	Figure 5.22
WAIT# hold time	t_{WTH}	0	—	ns	
Address delay time 2 (SDRAM)	t_{AD2}	1	12.5	ns	Figure 5.23
CS# delay time 2 (SDRAM)	t_{CSD2}	1	12.5	ns	
DQM delay time (SDRAM)	t_{DQMD}	1	12.5	ns	
CKE delay time (SDRAM)	t_{CKED}	1	12.5	ns	
Read data setup time 2 (SDRAM)	t_{RDS2}	10	—	ns	
Read data hold time 2 (SDRAM)	t_{RDH2}	0	—	ns	
Write data delay time 2 (SDRAM)	t_{WDD2}	—	12.5	ns	
Write data hold time 2 (SDRAM)	t_{WDH2}	1	—	ns	
WE# delay time (SDRAM)	t_{WED}	1	12.5	ns	
RAS# delay time (SDRAM)	t_{RASD}	1	12.5	ns	
CAS# delay time (SDRAM)	t_{CASD}	1	12.5	ns	

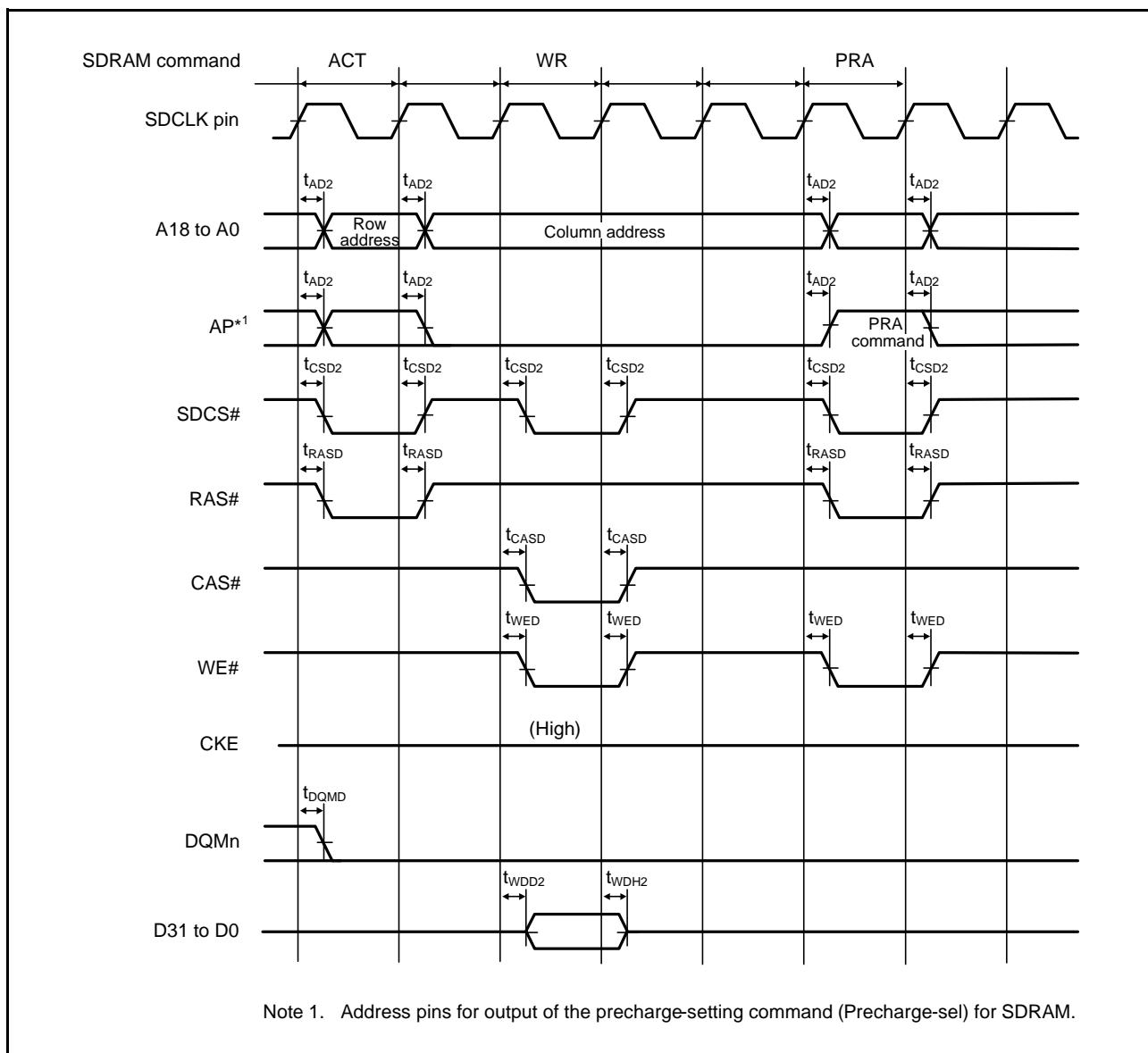


Figure 5.24 SDRAM Space Single Write Bus Timing

Table 5.28 POE3 Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
 VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
 VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
 PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, T_a = T_{opr}
 Output load conditions: V_{OH} = VCC × 0.5, V_{OL} = VCC × 0.5, C = 30 pF
 High-drive output is selected by the driving ability control register.

Item		Symbol	Min.	Max.	Unit ^{*1}	Test Conditions
POE	POE# input pulse width	t _{POEW}	1.5	—	t _{PBcyc}	Figure 5.40

Note 1. t_{PBcyc}: PCLKB cycle

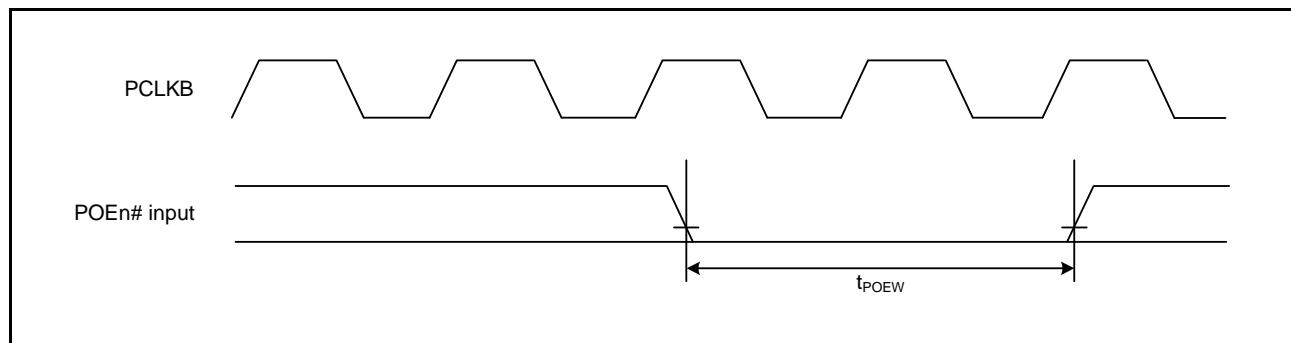
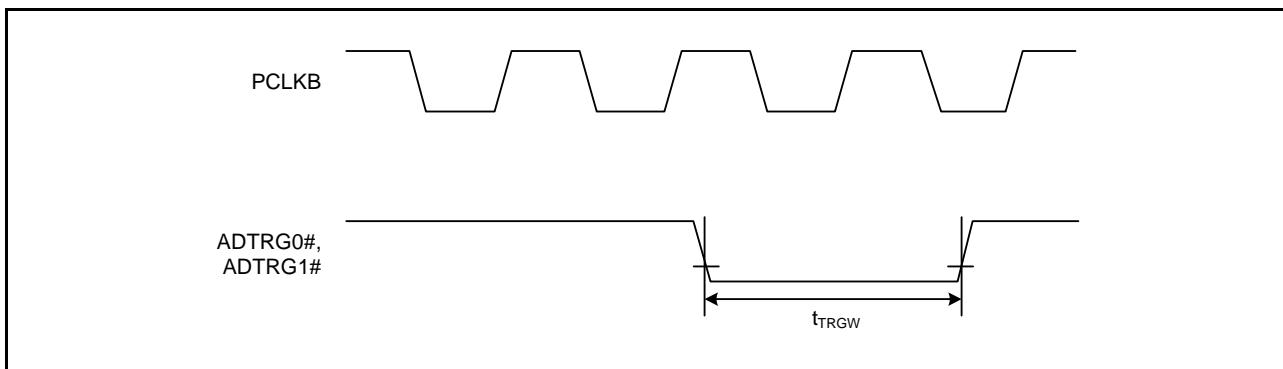
**Figure 5.40 POE# Input Timing**

Table 5.30 A/D Converter Trigger Timing

Conditions: $V_{CC} = AVCC_0 = AVCC_1 = VCC_USB = V_{BATT} = 2.7$ to 3.6 V, $2.7 \leq VREFH_0 \leq AVCC_0$, $VCC_USBA = AVCC_USBA = 3.0$ to 3.6 V, $VSS = AVSS_0 = AVSS_1 = VREFL_0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0$ V, $PCLKA = 8$ to 120 MHz, $PCLKB = 8$ to 60 MHz, $T_a = T_{opr}$
 Output load conditions: $V_{OH} = VCC \times 0.5$, $V_{OL} = VCC \times 0.5$, $C = 30$ pF
 High-drive output is selected by the driving ability control register.

Item		Symbol	Min.	Max.	Unit ^{*1}	Test Conditions
A/D converter	A/D converter trigger input pulse width	t_{TRGW}	1.5	—	t_{PBcyc}	Figure 5.43

Note 1. t_{PBcyc} : PCLKB cycle

**Figure 5.43 A/D Converter Trigger Input Timing****Table 5.31 CAC Timing**

Conditions: $V_{CC} = AVCC_0 = AVCC_1 = VCC_USB = V_{BATT} = 2.7$ to 3.6 V, $2.7 \leq VREFH_0 \leq AVCC_0$, $VCC_USBA = AVCC_USBA = 3.0$ to 3.6 V, $VSS = AVSS_0 = AVSS_1 = VREFL_0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0$ V, $PCLKA = 8$ to 120 MHz, $PCLKB = 8$ to 60 MHz, $T_a = T_{opr}$
 Output load conditions: $V_{OH} = VCC \times 0.5$, $V_{OL} = VCC \times 0.5$, $C = 30$ pF
 High-drive output is selected by the driving ability control register.

Item ^{*1, *2}		Symbol	Min.* ¹	Max.	Unit ^{*1}	Test Conditions
CAC	CACREF input pulse width	$t_{PBcyc} \leq t_{cac}$	t_{CACREF}	$4.5t_{cac} + 3t_{PBcyc}$	—	ns
		$t_{PBcyc} > t_{cac}$		$5t_{cac} + 6.5t_{PBcyc}$	—	

Note 1. t_{PBcyc} : PCLKB cycle

Note 2. t_{CAC} : CAC count clock source cycle

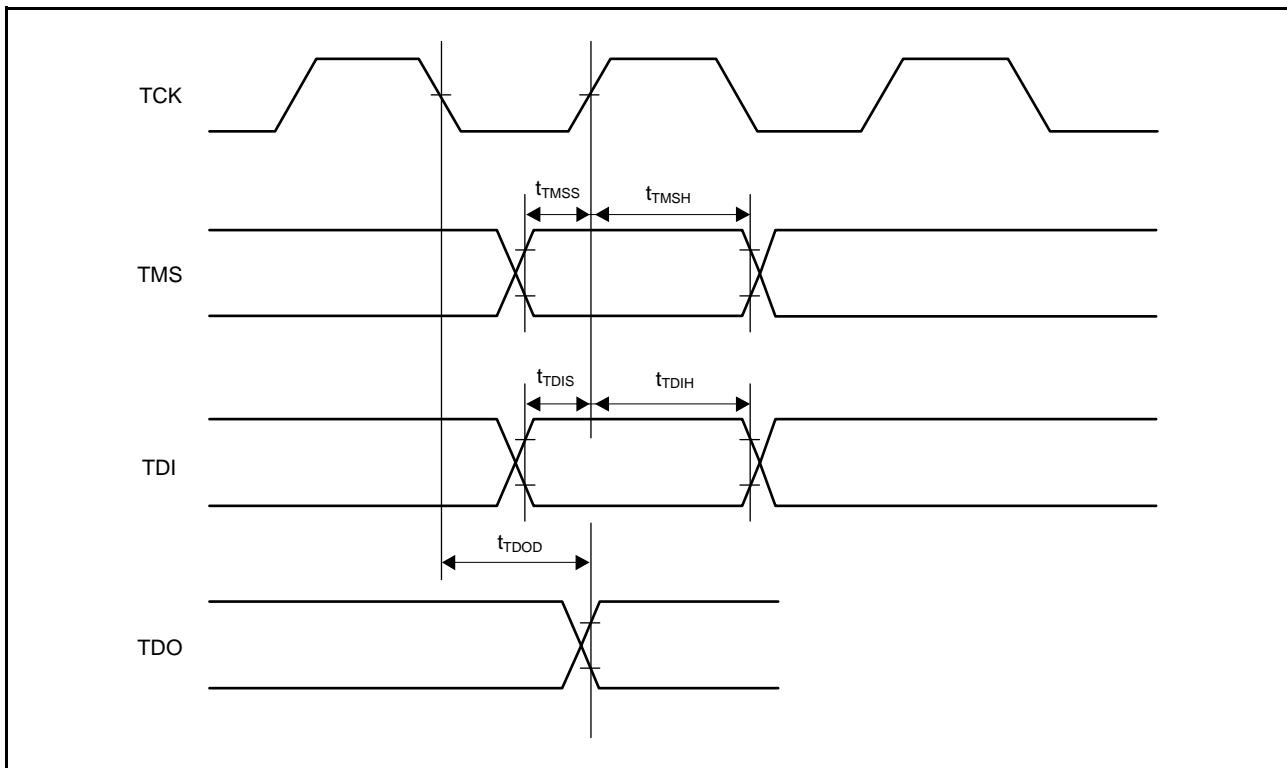


Figure 5.92 Boundary Scan Input/Output Timing

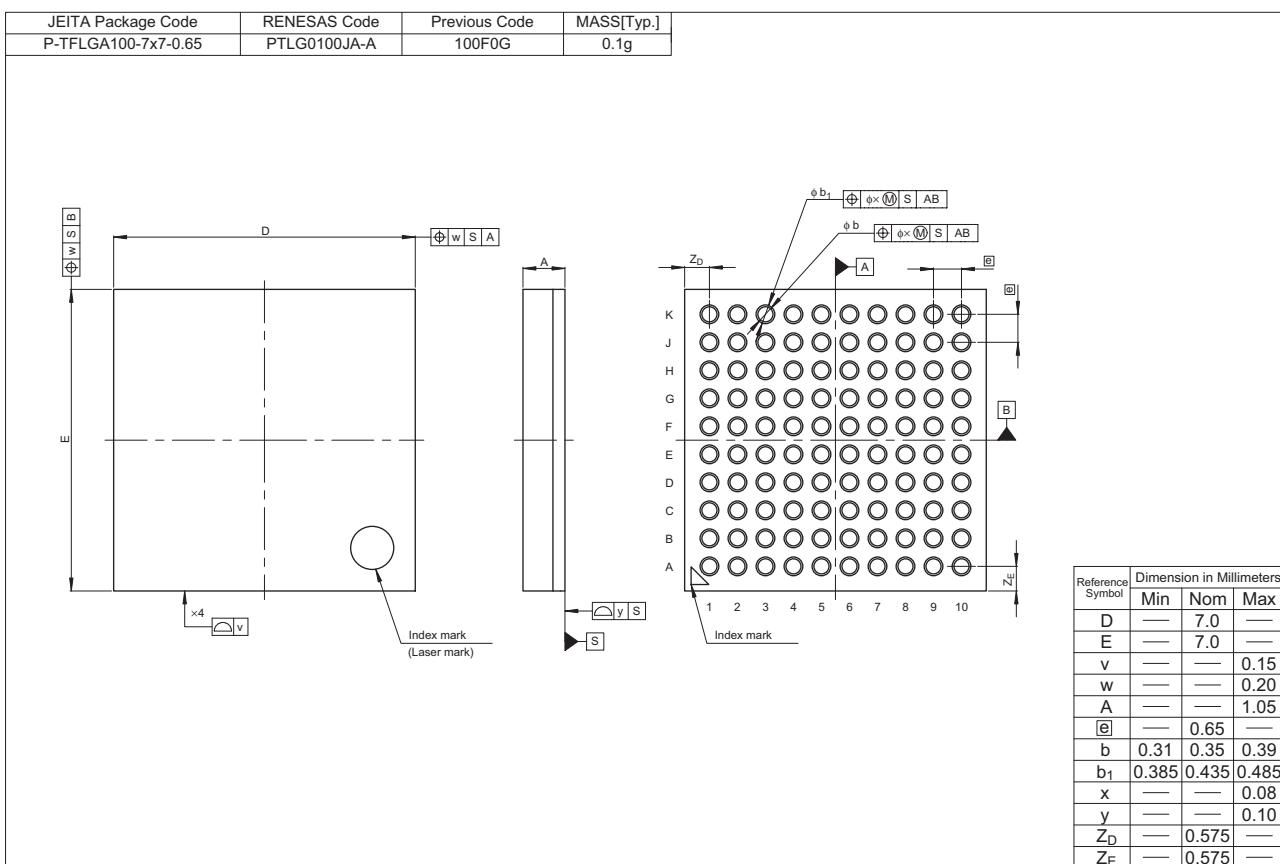


Figure F 100-Pin TFLGA (PTLG0100JA-A)